

Amendments to the Specification:

The paragraph beginning at Page 34, line 46, is to be amended as follows:

Figure 17A ~~and to~~ 17D are various views of the media cartridge depicted in Figures 14 -16;

The paragraph beginning at Page 60, lines 16 to 24, is to be amended as follows:

Returning to Figure 50, it can be seen that the end plate 3110 is shaped so as to conform with the regions 3115b and 3115c of the connector arrangement 3115, such that these regions can project into the casing 3020 for connection to the busbars 3071, 3072 and 3073 and the end PCB 3090, and so that the busbars 3071, 3072 and 3073 can extend to contact screws 3116a, 3116b and 3116c provided on the connector arrangement 3115. This particular shape of the end plate 3110 is shown in Figure 55A, where regions ~~3110a~~ 3110a and 3110b of the end plate 3110 correspond with the regions 3115b and 3115c of the connector arrangement 3115, respectively. Further, a region 3110c of the end plate 3110 is provided so as to enable connection between the internal fluid delivery tubes 3006 and the fluid delivery connectors 3047 and 3048 of the printhead module 3030.

The paragraph beginning at Page 61, lines 3 to 9, is to be amended as follows:

As can be seen from Figures 58A and 58B, like the connector arrangement 3115, the connector arrangement 3125 holds the power supply connection portion 3116 and includes places for contact screws for contact with the busbars 3071, 3072 and 3073, holes 3125a for retaining the clips 3118a of the fluid delivery portion 3118 (not shown), and regions 3125b and 3125c for extension into the casing 3020 through regions 3110a and 3110b of the end plate 3110, respectively (see Fig. 57). However, unlike the connector arrangement 3115, the connector arrangement 3125 does not hold the data connection portion 3117 and includes in place thereof a spring portion 3125d.

The paragraph beginning at Page 71, lines ^{20 22}~~28~~ to ~~28~~, is to be amended as follows:

A passivation layer in the form of a layer of silicon nitride ~~834~~3831 is positioned over the aluminium contact layers 3830 and the silicon dioxide layer 3817. Each portion of the passivation layer 3831 positioned over the contact layers 3830 has an opening 3832 defined therein to provide access to the contacts 3830.

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The paragraph beginning at Page 72, lines ¹³⁻¹⁵~~17-19~~, is to be amended as follows:

7/17/07
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In use, the device at rest is filled with ink 3813 that defines a meniscus ~~803~~⁸⁰³³⁸⁰³ under the influence of surface tension. The ink is retained in the chamber 3829 by the meniscus, and will not generally leak out in the absence of some other physical influence.